



## **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max       | Ι <sub>D</sub><br>T <sub>A</sub> = +25°C |
|-------------------|-------------------------------|--|
| -60V              | $250m\Omega @ V_{GS} = -10V$  | -2.1A                                    |
| -00 v             | $300m\Omega @ V_{GS} = -4.5V$ | -1.9A                                    |

## Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- Motor Control
- **DC-DC Converters**
- **Power Management Functions**
- Uninterrupted Power Supply

## **Features and Benefits**

- Low Gate Drive
- Low Input Capacitance
- Fast Switching Speed •
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

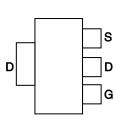
## **Mechanical Data**

- Case: SOT223 •
- Case Material: Molded Plastic, "Green" Molding Compound. • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (Approximate)

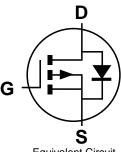


SOT223

Top View



Pin Out - Top View



Equivalent Circuit

### Ordering Information (Note 4)

|  | Part Number Qualification |          | Case   | Packaging           |  |
|--|---------------------------|----------|--------|---------------------|--|
|  | DMP6250SE-13              | Standard | SOT223 | 2,500 / Tape & Reel |  |
| Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. |                           |          |        |                     |  |

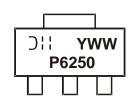
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



∃ = Manufacturer's Marking P6250 = Marking Code YWW = Date Code Marking  $\overline{Y}$  or Y = Year (ex: 7 = 2017) WW = Week (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                     | Symbol   | Value<br>-60    | Unit<br>V    |    |
|--|--|-----------------|--------------|----|
| Drain-Source Voltage                               | V <sub>DSS</sub>                                 |                 |              |    |
| Gate-Source Voltage (Note 5)                       |  | V <sub>GS</sub> | ±20          | V  |
|  | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | I <sub>D</sub>  | -2.1<br>-1.7 | А  |
| Continuous Drain Current (Note 6) $V_{GS} = -10V$  | T <sub>C</sub> = +25°C<br>T <sub>C</sub> = +70°C | I <sub>D</sub>  | -6.1<br>-4.9 | А  |
| Maximum Body Diode Continuous Current              | ls   | -1.8            | А            |    |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | I <sub>DM</sub>                                  | -11             | А            |    |
| Single Pulsed Avalanche Current (Note 7) L = 0.1mH | I <sub>AS</sub>                                  | -12             | А            |    |
| Single Pulsed Avalanche Energy (Note 7) L = 0.1mH  |  | E <sub>AS</sub> | 8            | mJ |

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol                 | Value            | Unit        |      |
|--|------------------------|------------------|-------------|------|
| Total Dower Discinction (Note 6)                 | T <sub>A</sub> = +25°C | D                | 1.8         | W    |
| Total Power Dissipation (Note 6)                 | T <sub>A</sub> = +70°C | PD               | 1.1         |      |
| Thermal Resistance, Junction to Ambient (Note 6) |                        | R <sub>θJA</sub> | 69          | °C/W |
| Total Power Dissipation (Note 6)                 | T <sub>C</sub> = +25°C | PD               | 14          | W    |
| Thermal Resistance, Junction to Case (Note 6)    | •                      | R <sub>θJC</sub> | 8.7         | °C/W |
| Operating and Storage Temperature Range          |                        | TJ, TSTG         | -55 to +150 | °C   |

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                              | Symbol              | Min | Тур  | Max  | Unit  | Test Condition  |  |
|---|---------------------|-----|------|------|-------|---|--|
| OFF CHARACTERISTICS (Note 8)                | • • • • • •         |     | . 76 |      | •     |   |  |
| Drain-Source Breakdown Voltage              | BV <sub>DSS</sub>   | -60 | _    | _    | V     | I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V               |  |
| Zero Gate Voltage Drain Current             | IDSS                | _   | _    | -1   | μA    | $V_{DS} = -60V, V_{GS} = 0V$                                |  |
| Gate-Source Leakage                         | Igss                |     | —    | ±100 | nA    | $V_{GS} = \pm 20V, V_{DS} = 0V$                             |  |
| ON CHARACTERISTICS (Note 8)                 |                     |     |      |      |       | ·   |  |
| Gate Threshold Voltage                      | V <sub>GS(TH)</sub> | -1  | _    | -3   | V     | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$                       |  |
|   |                     |     | 128  | 250  |       | $V_{GS} = -10V, I_D = -1.0A$                                |  |
| Static Drain-Source On-Resistance           |                     |     | 128  | 250  | mΩ    | $V_{GS} = -10V, I_D = -1.9A$                                |  |
| Static Drain-Source Off-Resistance          | R <sub>DS(ON)</sub> | _   | 156  | 300  | 11122 | $V_{GS} = -4.5V, I_D = -0.5A$                               |  |
|   |                     |     | 158  | 300  |       | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.5A             |  |
| Diode Forward Voltage                       | V <sub>SD</sub>     |     | _    | -1.2 | V     | $V_{GS} = 0V, I_{S} = -2.0A$                                |  |
| DYNAMIC CHARACTERISTICS (Note 9)            |                     |     |      |      |       | ·   |  |
| Input Capacitance                           | Ciss                | _   | 551  | _    | pF    |   |  |
| Output Capacitance                          | Coss                | _   | 25.7 | _    | pF    | − V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V<br>− f= 1MHz |  |
| Reverse Transfer Capacitance                | C <sub>rss</sub>    | _   | 19.1 | _    | pF    |   |  |
| Gate Resistance                             | Rg                  | _   | 12.1 | _    | Ω     | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$                  |  |
| Total Gate Charge (V <sub>GS</sub> = -4.5V) | Qg                  | _   | 4.8  | _    | nC    |   |  |
| Total Gate Charge (V <sub>GS</sub> = -10V)  | Qg                  | _   | 9.7  | _    | nC    | N/ 201/ I 24  |  |
| Gate-Source Charge                          | Q <sub>gs</sub>     | _   | 1.5  | _    | nC    | $V_{DS} = -30V, I_D = -2A$                                  |  |
| Gate-Drain Charge                           | Q <sub>gd</sub>     | _   | 1.6  | _    | nC    |   |  |
| Turn-On Delay Time                          | t <sub>D(ON)</sub>  | _   | 6.3  | _    | ns    | V <sub>DS</sub> = -30V, V <sub>GS</sub> = -10V,             |  |
| Turn-On Rise Time                           | t <sub>R</sub>      | _   | 10.3 | _    | ns    |   |  |
| Turn-Off Delay Time                         | t <sub>D(OFF)</sub> | _   | 91.4 | _    | ns    | $R_G = 50\Omega, I_D = -1A$                                 |  |
| Turn-Off Fall Time                          | tF                  |     | 39.8 | _    | ns    | 7   |  |
| Reverse Recovery Time                       | t <sub>RR</sub>     |     | 9.2  | _    | ns    |   |  |
| Reverse Recovery Charge                     | Q <sub>RR</sub>     |     | 3.9  | —    | nC    | -I <sub>S</sub> = -1A, di/dt= 100A/μs                       |  |

Notes:

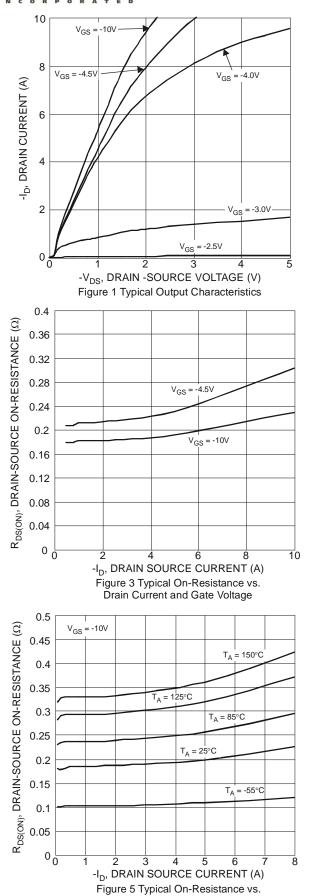
5. AEC-Q101  $V_{GS}$  maximum is ±16V. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

8. Short duration pulse test used to minimize self-heating effect.

9. For design aid only, not subject to production testing.





Drain Current and Temperature

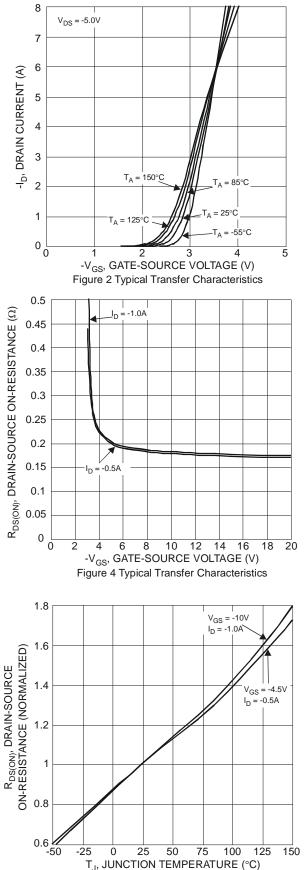
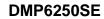
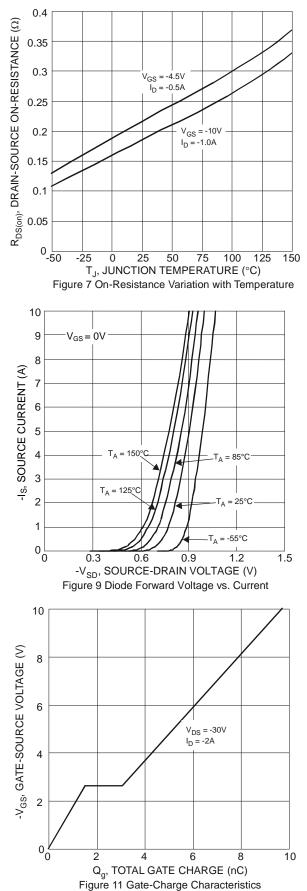


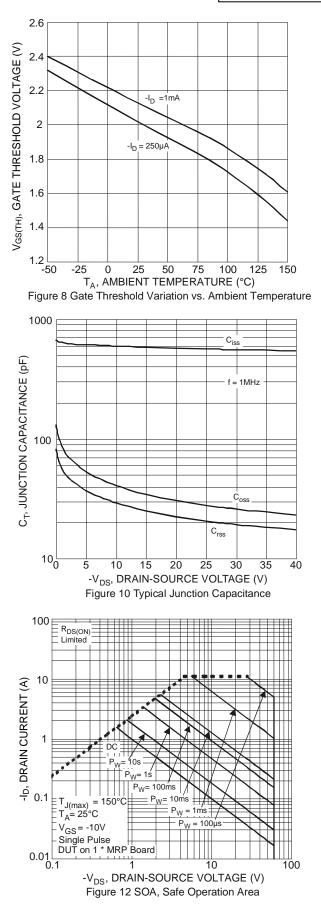
Figure 6 On-Resistance Variation with Temperature

DMP6250SE

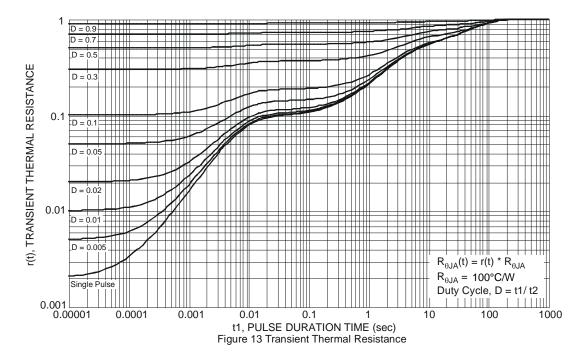








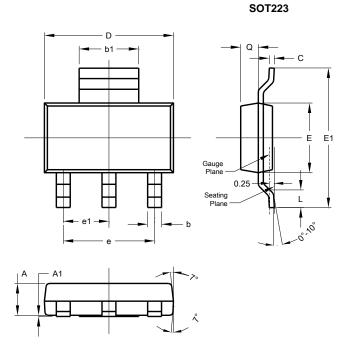






## **Package Outline Dimensions**

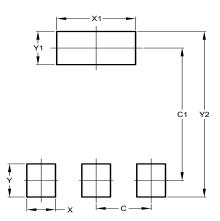
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SOT223 |                      |      |      |  |  |
|--------|----------------------|------|------|--|--|
| Dim    | Min                  | Max  | Тур  |  |  |
| Α      | 1.55                 | 1.65 | 1.60 |  |  |
| A1     | 0.010                | 0.15 | 0.05 |  |  |
| b      | 0.60                 | 0.80 | 0.70 |  |  |
| b1     | 2.90                 | 3.10 | 3.00 |  |  |
| С      | 0.20                 | 0.30 | 0.25 |  |  |
| D      | 6.45                 | 6.55 | 6.50 |  |  |
| E      | 3.45                 | 3.55 | 3.50 |  |  |
| E1     | 6.90                 | 7.10 | 7.00 |  |  |
| е      | -                    | -    | 4.60 |  |  |
| e1     | -                    | -    | 2.30 |  |  |
| L      | 0.85                 | 1.05 | 0.95 |  |  |
| Q      | 0.84                 | 0.94 | 0.89 |  |  |
| All    | All Dimensions in mm |      |      |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| <u> </u>   | [             |
|------------|---------------|
| Dimensions | Value (in mm) |
| С          | 2.30          |
| C1         | 6.40          |
| Х          | 1.20          |
| X1         | 3.30          |
| Y          | 1.60          |
| Y1         | 1.60          |
| Y2         | 8.00          |

#### DMP6250SE Document Number DS36696 Rev. 2 - 2

SOT223



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